

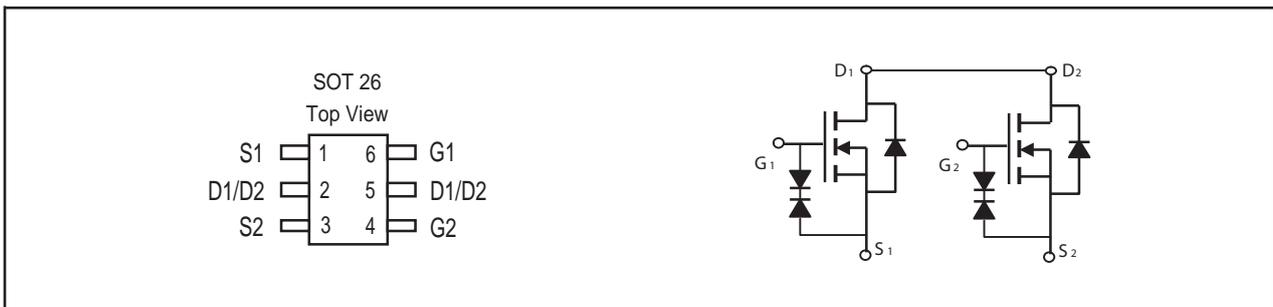


Dual N-Channel Enhancement Mode Field Effect Transistor

PRODUCT SUMMARY		
V _{DSS}	I _D	R _{DS(ON)} (mΩ) Max
20V	7A	17.5 @ V _{GS} =4.5V
		18.5 @ V _{GS} =4.0V
		19.0 @ V _{GS} =3.7V
		22.0 @ V _{GS} =3.1V
		27.5 @ V _{GS} =2.5V

FEATURES

- Super high dense cell design for low R_{DS(ON)}.
- Rugged and reliable.
- Surface Mount Package.
- ESD HBM > 2KV.



ABSOLUTE MAXIMUM RATINGS (T_A=25°C unless otherwise noted)

Symbol	Parameter	Limit	Units
V _{DS}	Drain-Source Voltage	20	V
V _{GS}	Gate-Source Voltage	±12	V
I _D	Drain Current-Continuous ^a	T _A =25°C	7.0
		T _A =70°C	5.6
I _{DM}	-Pulsed ^b	45	A
P _D	Maximum Power Dissipation ^a	T _A =25°C	1.25
		T _A =70°C	0.8
T _J , T _{STG}	Operating Junction and Storage Temperature Range	-55 to 150	°C

THERMAL CHARACTERISTICS

R _{θJA}	Thermal Resistance, Junction-to-Ambient ^a	100	°C/W
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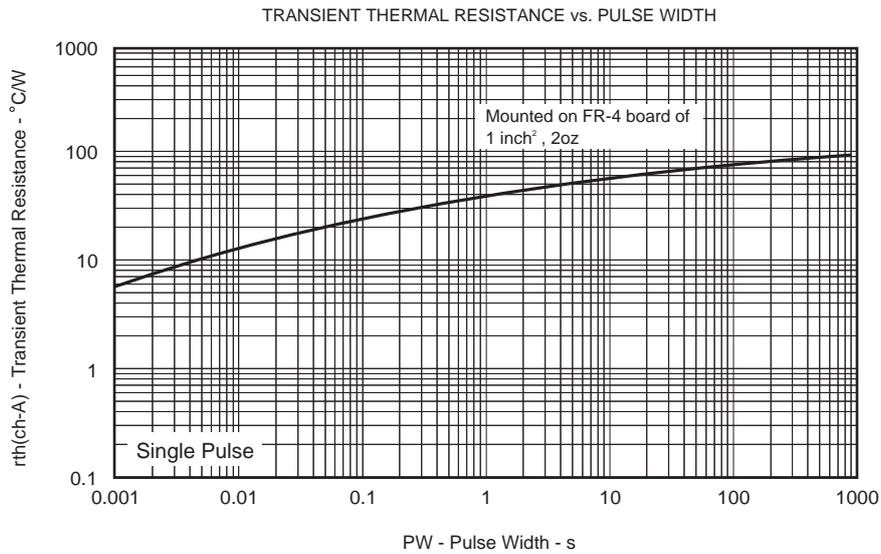
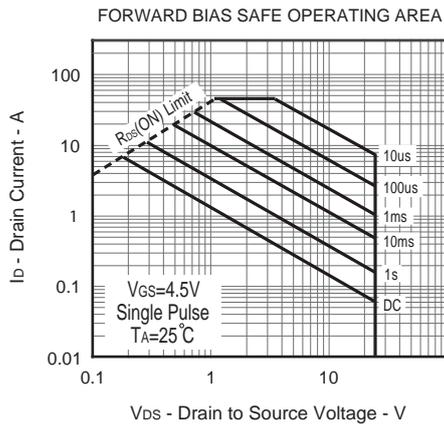
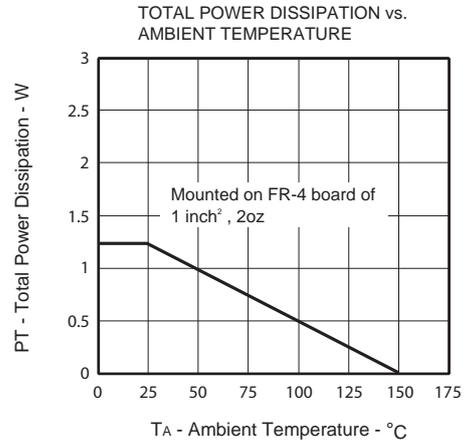
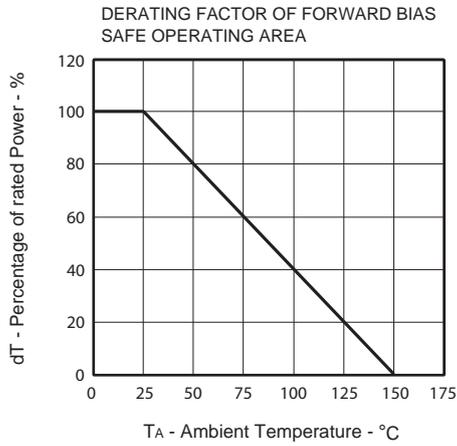
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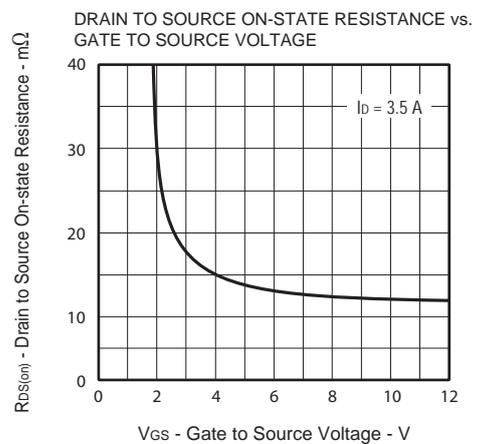
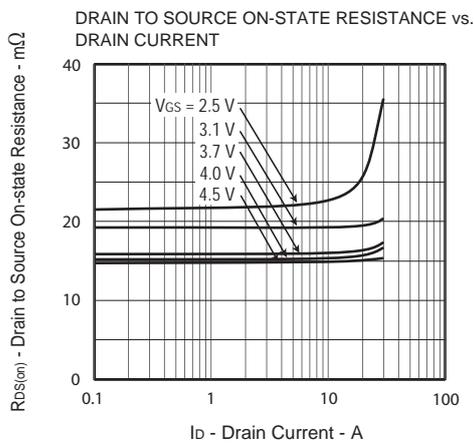
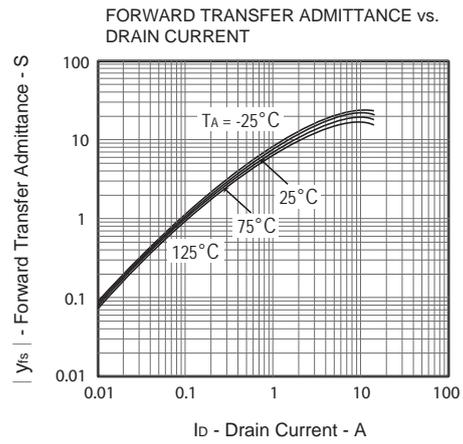
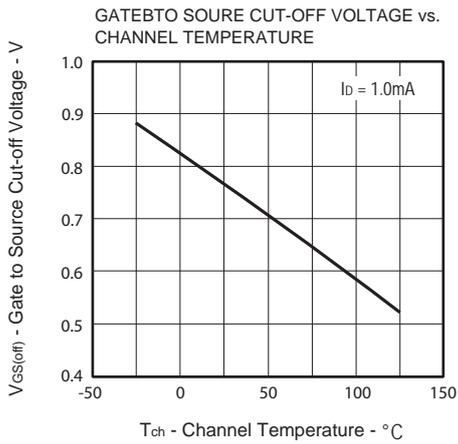
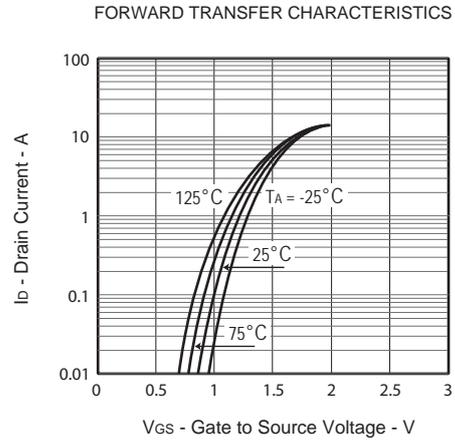
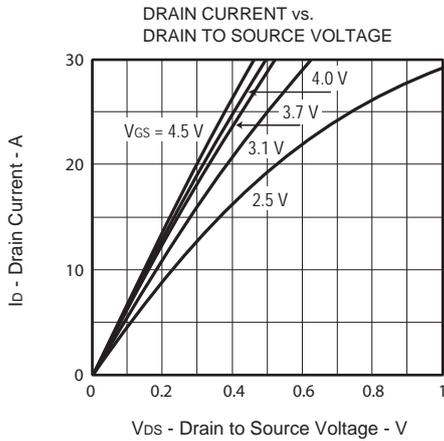
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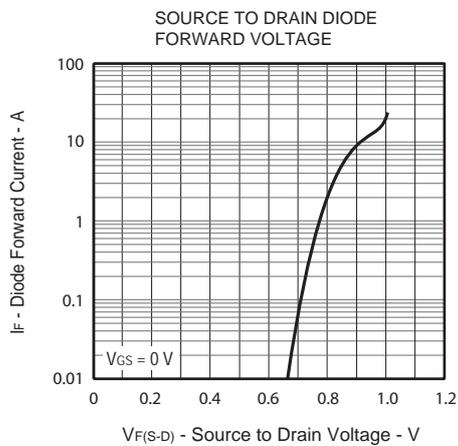
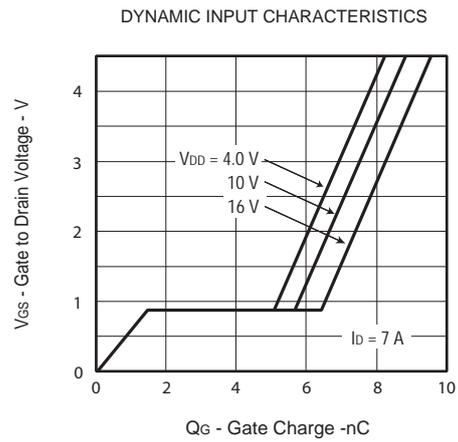
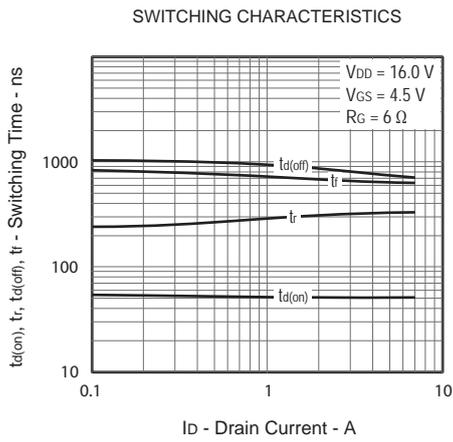
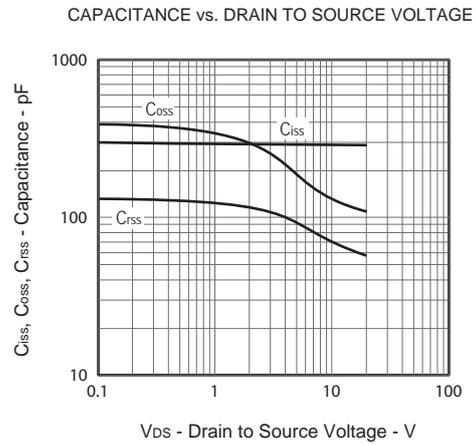
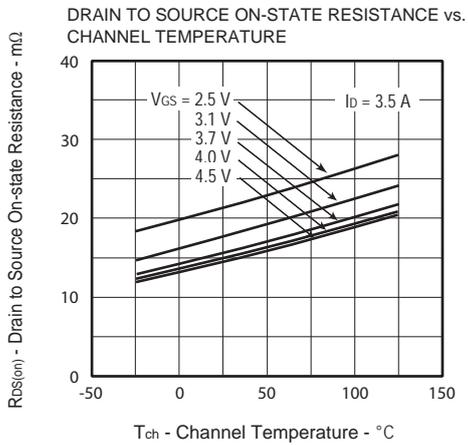
ELECTRICAL CHARACTERISTICS (T_A=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
OFF CHARACTERISTICS						
BV _{bss}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	20			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =16V , V _{GS} =0V			1	uA
I _{GSS}	Gate-Body Leakage Current	V _{GS} = ±12V , V _{DS} =0V			±10	uA
ON CHARACTERISTICS						
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =1mA	0.5	0.75	1.5	V
R _{DS(ON)}	Drain-Source On-State Resistance	V _{GS} =4.5V , I _D =3.5A	13	15	17.5	m ohm
		V _{GS} =4.0V , I _D =3.5A	13.5	15.5	18.5	m ohm
		V _{GS} =3.7V , I _D =3.5A	14	16	19	m ohm
		V _{GS} =3.1V , I _D =3.5A	15	18	22	m ohm
		V _{GS} =2.5V , I _D =3.5A	17.5	22	27.5	m ohm
g _{FS}	Forward Transconductance	V _{DS} =5V , I _D =3.5A		20		S
DYNAMIC CHARACTERISTICS ^c						
C _{ISS}	Input Capacitance	V _{DS} =10V, V _{GS} =0V f=1.0MHz		298		pF
C _{OSS}	Output Capacitance			148		pF
C _{RSS}	Reverse Transfer Capacitance			72		pF
SWITCHING CHARACTERISTICS ^c						
t _{D(ON)}	Turn-On Delay Time	V _{DD} =16V I _D =3.5A V _{GS} =4.5V R _{GEN} = 6 ohm		55		ns
t _r	Rise Time			293		ns
t _{D(OFF)}	Turn-Off Delay Time			793		ns
t _f	Fall Time			672		ns
Q _g	Total Gate Charge				9.4	
Q _{gs}	Gate-Source Charge	V _{DS} =16V, I _D =7A, V _{GS} =4.5V		1.4		nC
Q _{gd}	Gate-Drain Charge			4.9		nC
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS						
V _{SD}	Diode Forward Voltage	V _{GS} =0V, I _S =1.0A		0.78	1.2	V
Notes						
a.Surface Mounted on FR4 Board, t < 10sec.						
b.Pulse Test:Pulse Width < 10us, Duty Cycle < 1%.						
c.Guaranteed by design, not subject to production testing.						

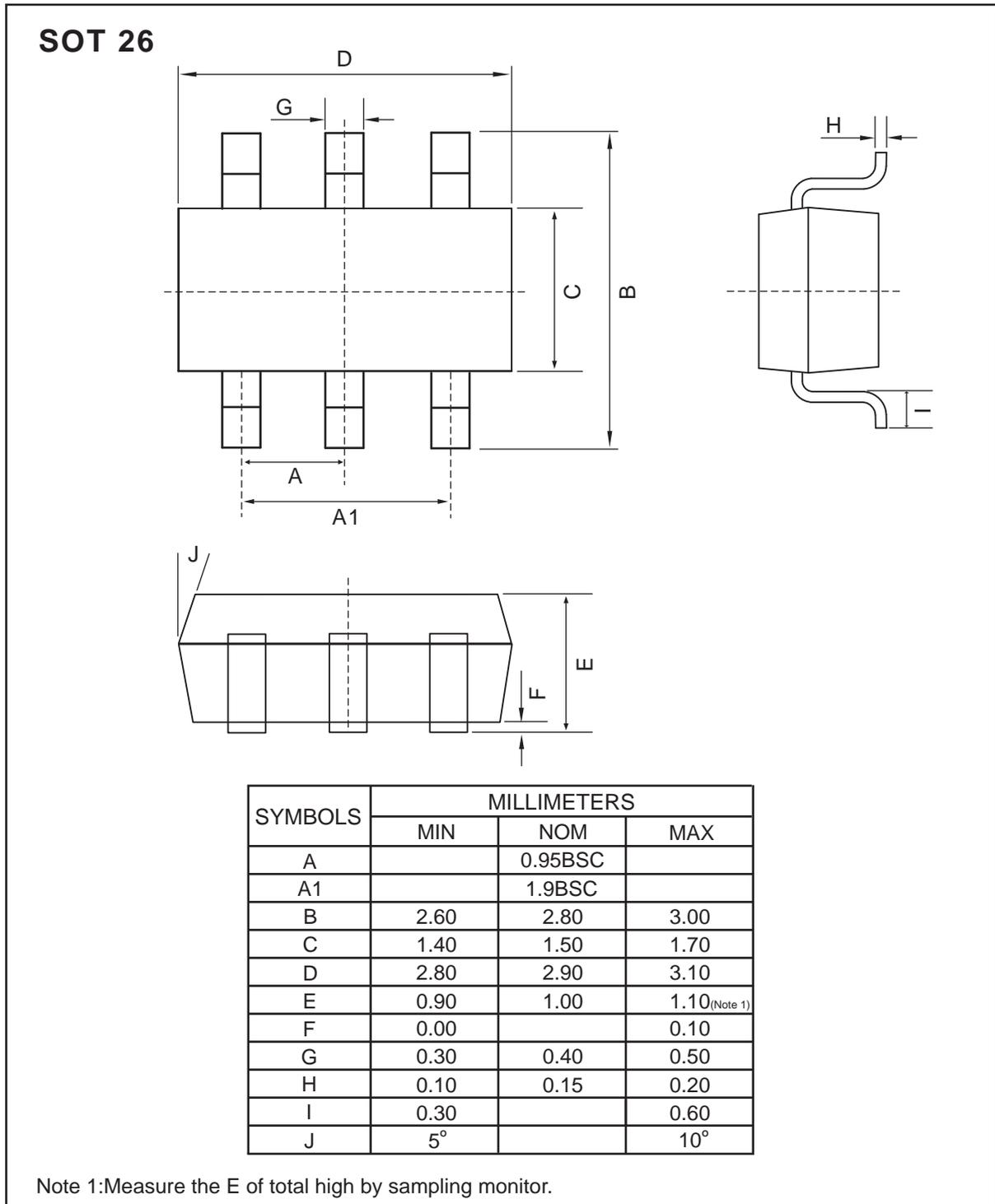
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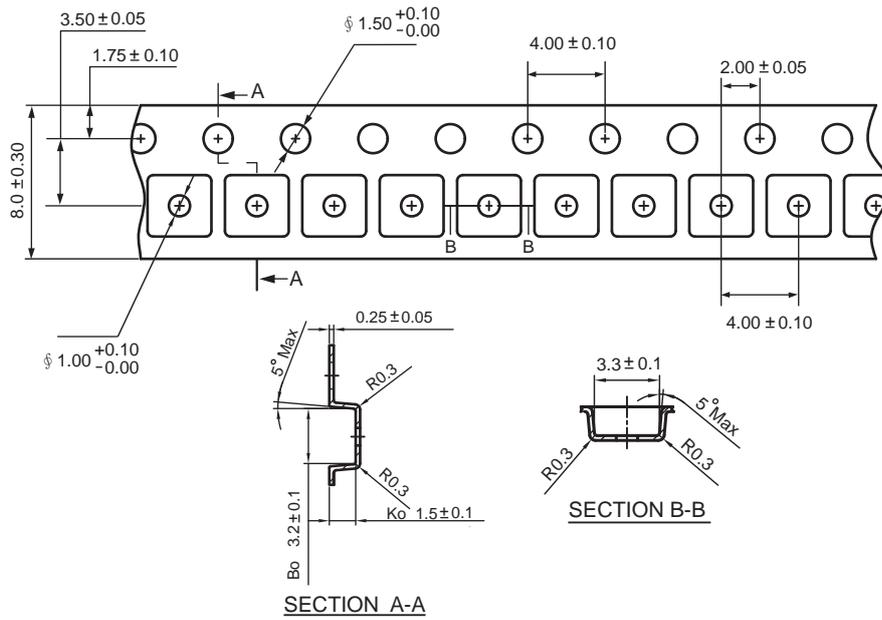


PACKAGE OUTLINE DIMENSIONS



SOT 26 Tape and Reel Data

SOT 26 Carrier Tape



SOT 26 Reel

